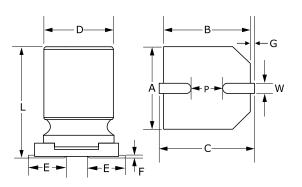
KEMET Part Number: A767KN226M1HLAE050



Polymer Aluminum, 105C LowZ, A767, 22 uF, 20%, 50 V, -55/+105C



| General Information | |
|---------------------|------------------------------------|
| Dielectric: | Polymer Aluminum |
| Style: | SMD Can |
| Series: | A767 |
| Description: | Surface Mount, Polymer Aluminum |
| RoHS: | Yes |
| Lead: | V-Chip |

| Dimensions | |
|------------|-----------------|
| D | 8mm +/-0.5mm |
| L | 9.7mm +/-0.3mm |
| W | 0.8 - 1.1mm |
| F | 0.2mm MAX |
| Α | 8.3mm +/-0.2mm |
| В | 8.3mm +/-0.2mm |
| C | 9mm +/-0.2mm |
| E | 2.9mm +/-0.2mm |
| G | 0.35mm +/-0.2mm |
| Р | 3.2mm +/-0.2mm |

| Packaging Specifications | | |
|--------------------------|------------|--|
| Packaging: | T&R, 380mm | |
| Packaging Quantity: | 500 | |

| Specifications | |
|--------------------------|--------------------------|
| Capacitance: | 22 uF |
| Capacitance Tolerance: | 20% |
| Voltage DC: | 50 VDC, 57.5 VDC (Surge) |
| Temperature Range: | -55/+105C |
| Rated Temperature: | 105C |
| Life: | 2000 Hrs |
| Resistance: | 50 mOhms (100kHz 20C) |
| Current: | 1500 mAmps (100kHz 105C) |
| Leakage Current: | 300 uA (2min 20C) |
| Impedance Ratio at -25C: | 1.25 |
| Impedance Ratio at -55C: | 1.25 |
| High Temperature Solder: | No |

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